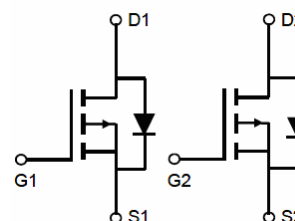
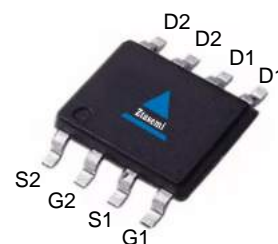


Features

- Dual P-Channel
- High power and current handing capability
- Lead free product is acquired
- Surface mount package
- 100% EAS Tested

V_{DS}	-30	V
$R_{DS(on),TYP@ V_{GS}=-10V}$	13	m Ω
$R_{DS(on),TYP@ V_{GS}=-4.5V}$	15	m Ω
I_D	-8	A

SOP-8


Part ID	Package Type	Marking	Packing
ZT11B03S	SOP-8	ZT11B03S	4000pcs/reel

Absolute Maximum Ratings $T_A = 25^\circ\text{C}$, unless otherwise specified

Symbol	Parameter	Rating	Unit	
Common Ratings ($T_c=25^\circ\text{C}$ Unless Otherwise Noted)				
V_{GS}	Gate-Source Voltage	± 20	V	
$V_{(BR)DSS}$	Drain-Source Breakdown Voltage	-30	V	
T_J	Maximum Junction Temperature	150	$^\circ\text{C}$	
T_{STG}	Storage Temperature Range	-55 to 150	$^\circ\text{C}$	
I_{DM}	Drain Current-Continuous@ Current-Pulsed (Note 1)	$T_C = 25^\circ\text{C}$ -32	A	
Mounted on Large Heat Sink				
I_D	Drain Current-Continuous	$T_C = 25^\circ\text{C}$	-8	A
		$T_C = 100^\circ\text{C}$	-5.7	A
P_D	Maximum Power Dissipation	$T_C = 25^\circ\text{C}$	3.1	W
$R_{\theta JA}$	Thermal Resistance Junction-ambient (Note 2)		40	$^\circ\text{C/W}$

Electrical Characteristics (T_j=25°C unless otherwise noted)

Symbol	Parameter	Condition	Min	Typ	Max	Unit
Static Electrical Characteristics @ T_j=25°C (unless otherwise stated)						
V(BR)DSS	Drain-Source Breakdown Voltage	V _{GS} =0V, I _D =-250μA	-30	--	--	V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =-30V, V _{GS} =0V	--	--	-1	μA
I _{GSS}	Gate-Body Leakage Current	V _{GS} =±20V, V _{DS} =0V	--	--	±100	nA
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _D =-250μA	-1.0	-1.6	-2.5	V
R _{DS(on)}	Drain-Source On-State Resistance	V _{GS} =-10V, I _D =-6A	--	13	16	mΩ
R _{DS(on)}	Drain-Source On-State Resistance	V _{GS} =-4.5V, I _D =-4A	--	15	21	mΩ
g _{FS}	Forward Transconductance	V _{DS} =-5V, I _D =-6A	10	--	--	S
Dynamic Electrical Characteristics @ T_j = 25°C (unless otherwise stated) (Note 4)						
C _{iss}	Input Capacitance	V _{DS} =-15V, V _{GS} =0V, f=1MHz	--	1595	--	pF
C _{oss}	Output Capacitance		--	348	--	pF
C _{rss}	Reverse Transfer Capacitance		--	299	--	pF
R _g	Gate Resistance	f=1MHz	--	12	--	Ω
Q _g	Total Gate Charge	V _{DS} =-15V, I _D =-6A, V _{GS} =-4.5V	--	17.6	--	nC
Q _{gs}	Gate-Source Charge		--	5.4	--	nC
Q _{gd}	Gate-Drain Charge		--	8	--	nC
Switching Characteristics (Note 4)						
T _{d(on)}	Turn-on Delay Time	V _{DS} =-15V, I _D =-6A, R _G =6Ω, V _{GS} =-10V	--	10	--	ns
T _r	Turn-on Rise Time		--	14	--	ns
T _{d(off)}	Turn-Off Delay Time		--	109	--	ns
T _f	Turn-Off Fall Time		--	69	--	ns
Source- Drain Diode Characteristics @ T_j = 25°C (unless otherwise stated)						
I _{SD}	Source-Drain Current (Body Diode)		--	--	-8	A
V _{SD}	Forward on voltage (Note 3)	I _S =-6A, V _{GS} =0V	--	--	1.2	V
T _{rr}	Reverse Recovery Time	T _j =25°C, I _F =-3A, V _{GS} =0V	--	14.1	--	ns
Q _{rr}	Reverse Recovery Charge	di/dt=100A/μs	--	4.8	--	nC

Notes:

1. Repetitive Rating: Pulse width limited by maximum junction temperature.
2. Surface Mounted on FR4 Board, t ≤ 10 sec.
3. Pulse Test: Pulse Width ≤ 300μs, Duty Cycle ≤ 2%.
4. Guaranteed by design, not subject to production

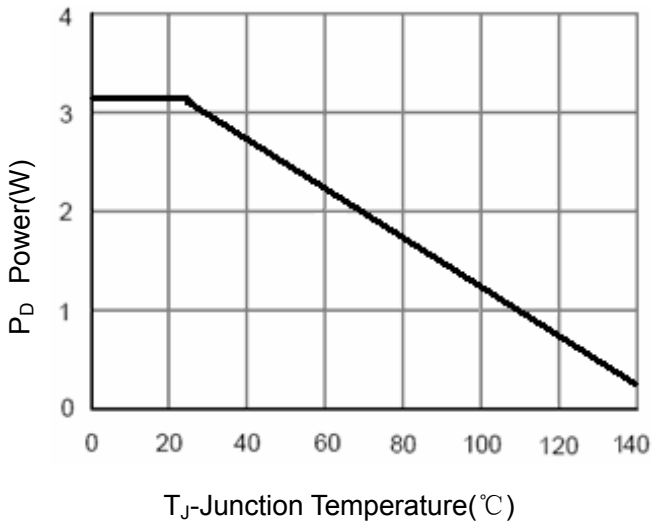


Figure 1 Power Dissipation

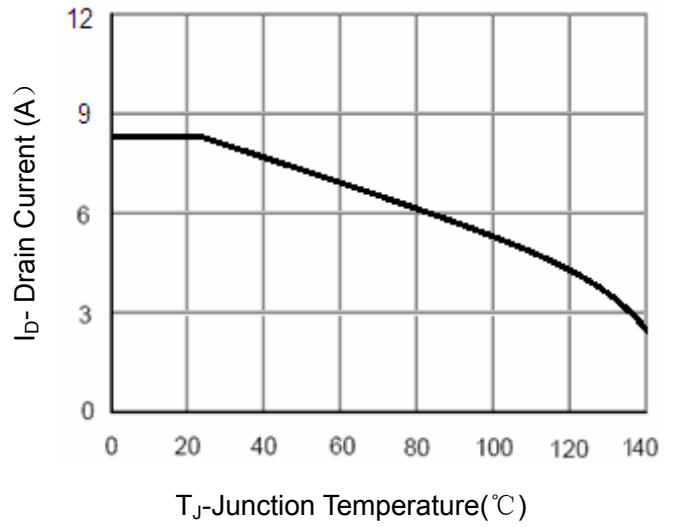


Figure 4 Drain Current

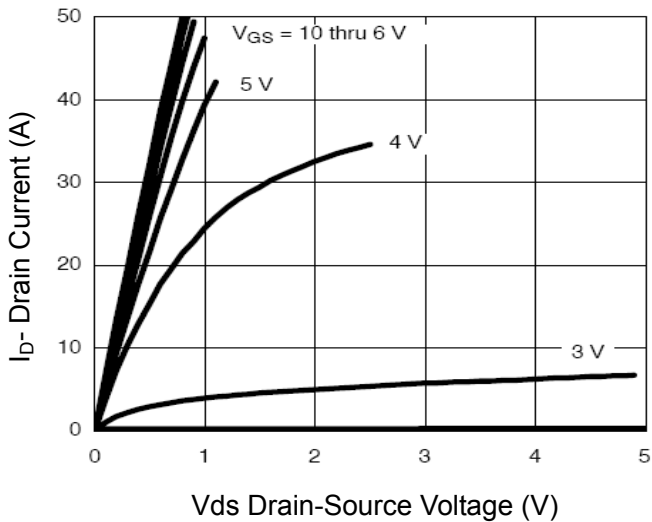


Figure 2 Output Characteristics

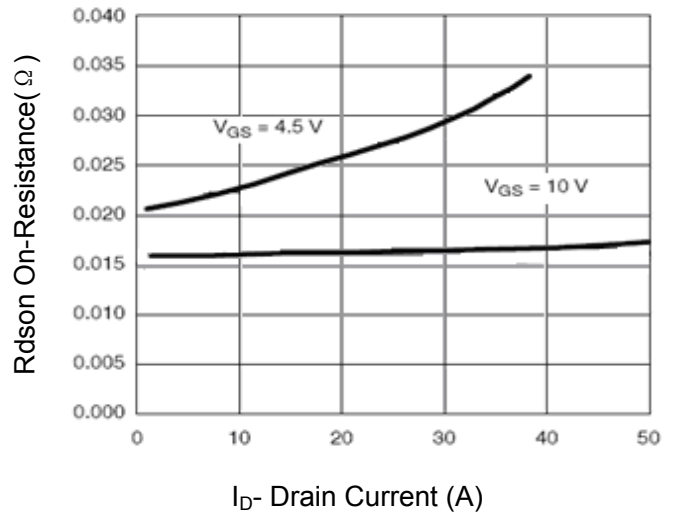


Figure 5 Drain-Source On-Resistance

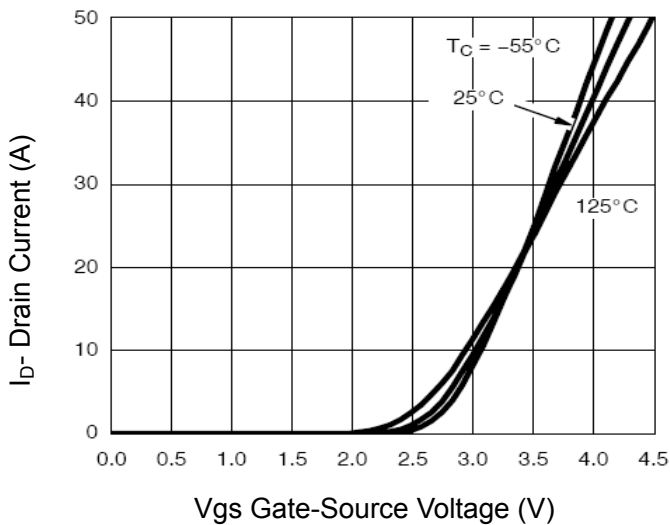


Figure 3 Transfer Characteristics

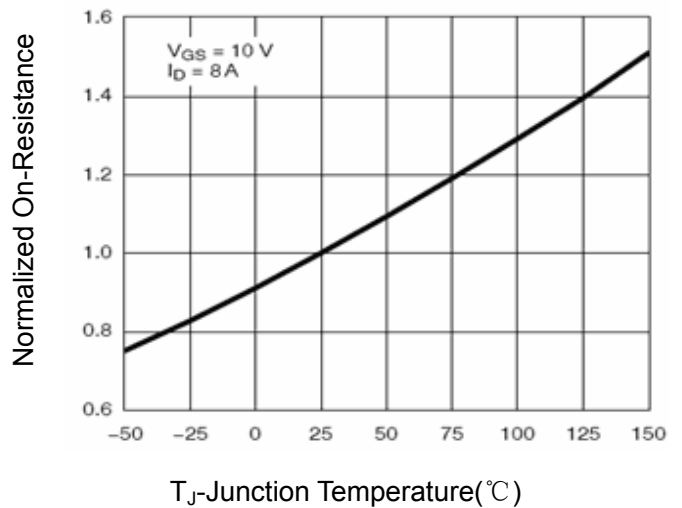


Figure 6 Drain-Source On-Resistance

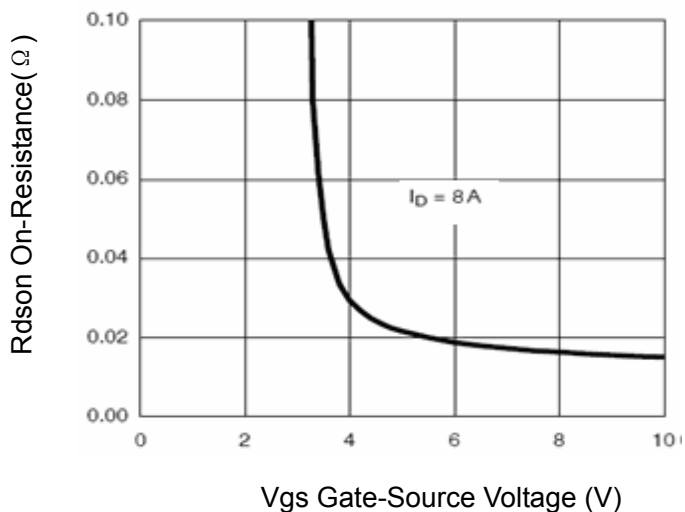


Figure 7 Rdson vs Vgs

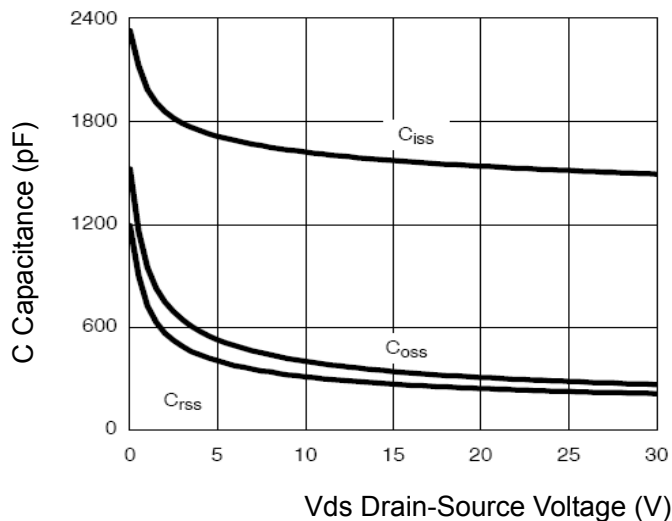


Figure 9 Capacitance vs Vds

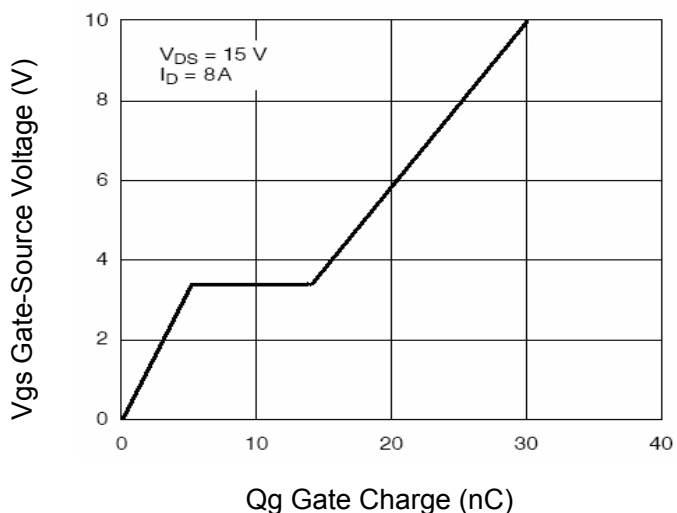


Figure 8 Gate Charge

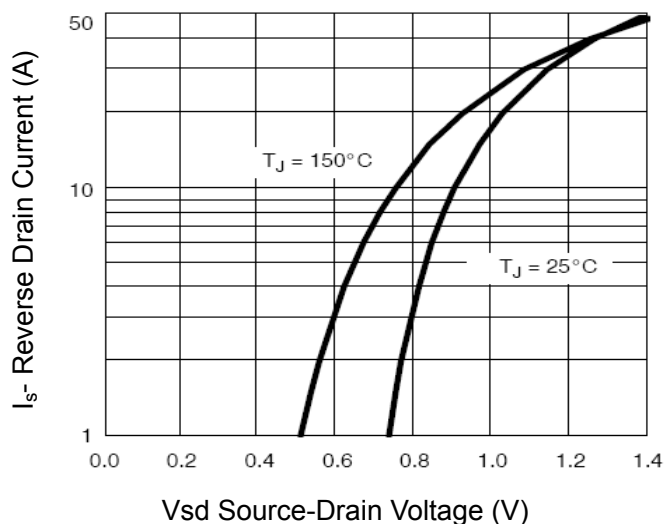


Figure 10 Source- Drain Diode Forward

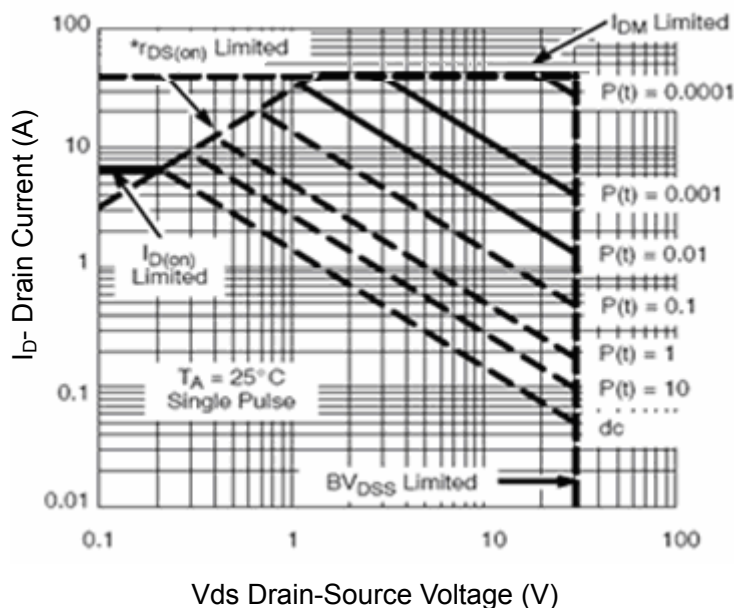


Figure 11 Safe Operation Area

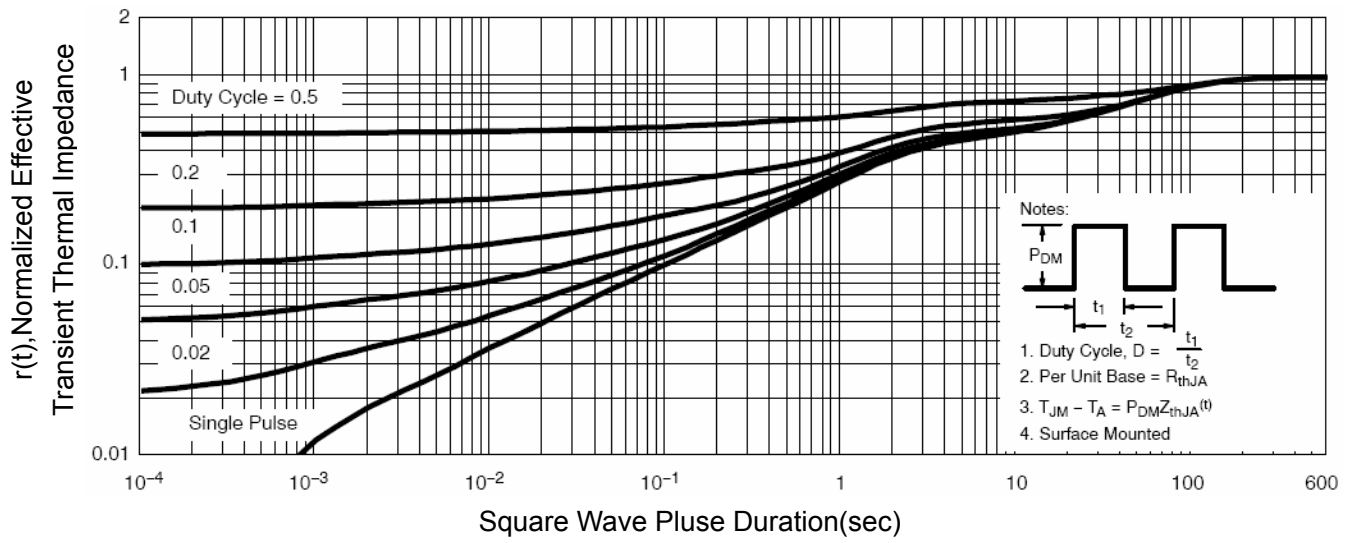
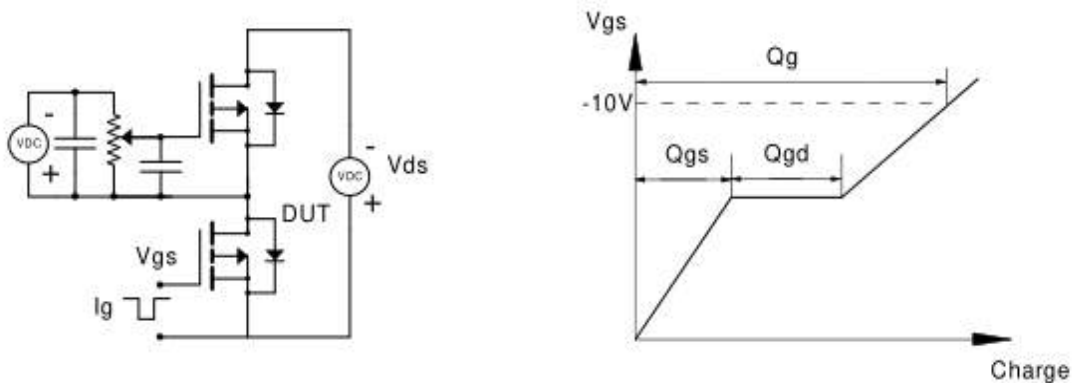


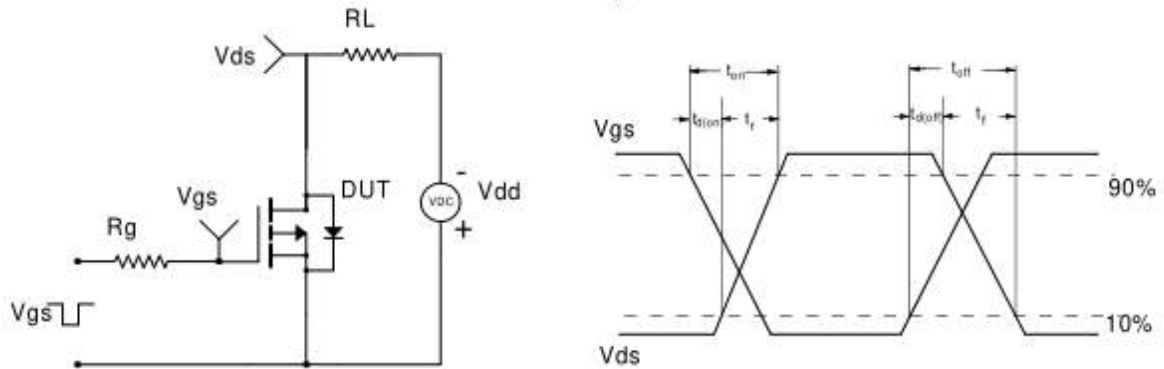
Figure 12 Normalized Maximum Transient Thermal Impedance

Test Circuit

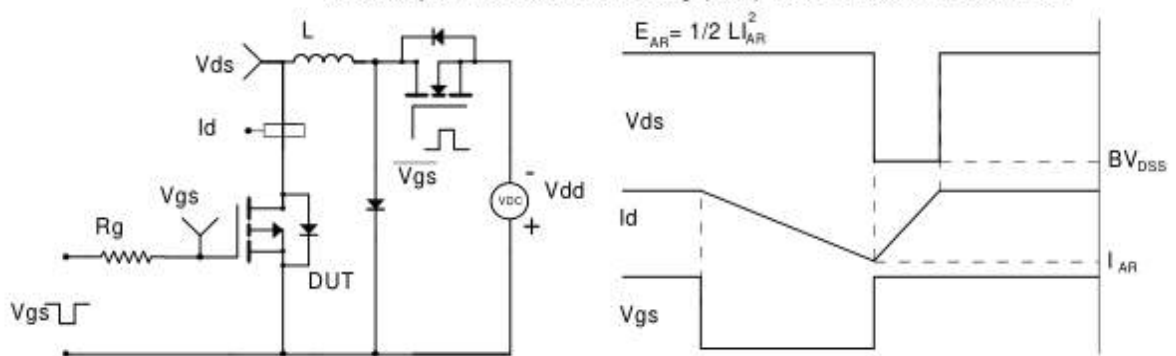
Gate Charge Test Circuit & Waveform



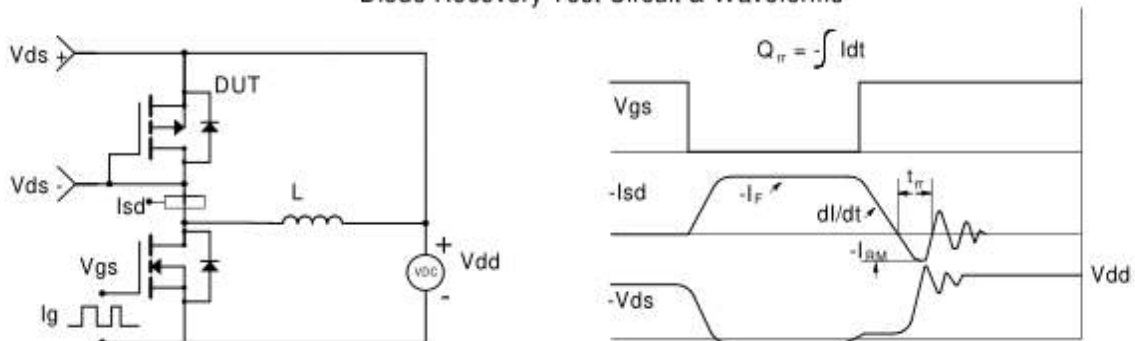
Resistive Switching Test Circuit & Waveforms



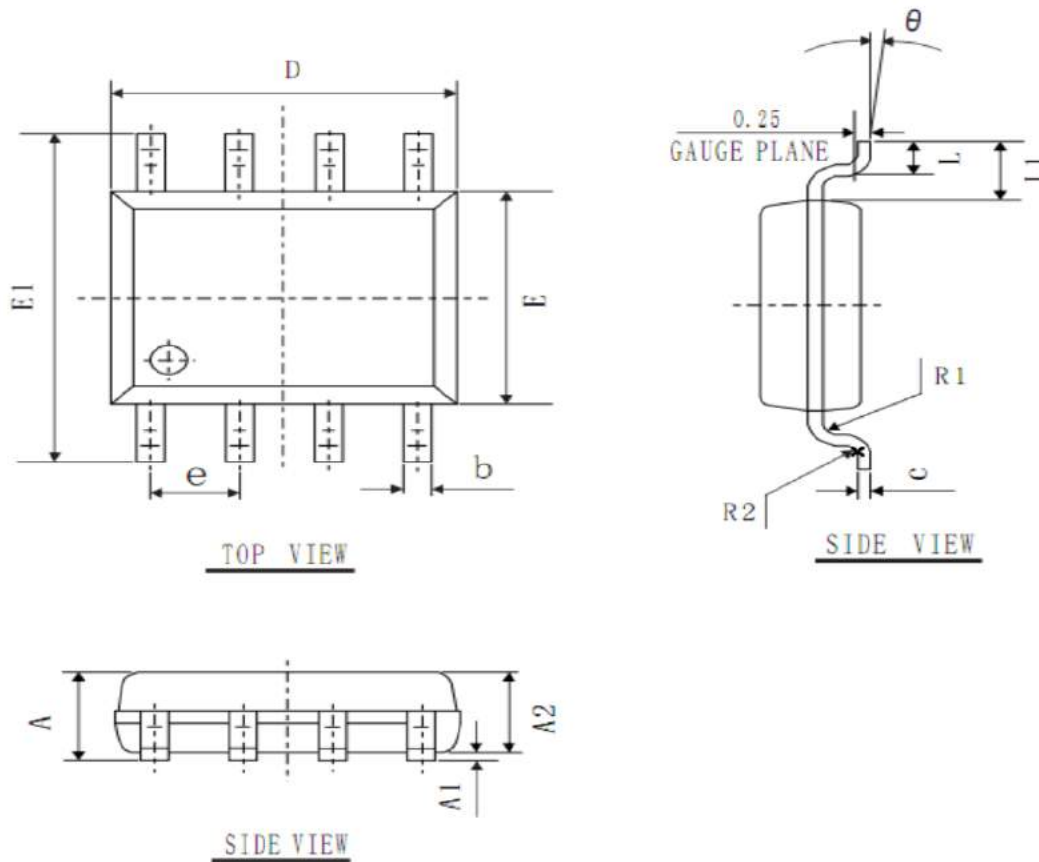
Unclamped Inductive Switching (UIS) Test Circuit & Waveforms



Diode Recovery Test Circuit & Waveforms



SOP-8 Package Information



COMMON DIMENSIONS
(UNITS OF MEASURE=mm)

SYMBOL	MIN	NOM	MAX
A	1.40	1.60	1.80
A1	0.05	0.15	0.25
A2	1.35	1.45	1.55
b	0.30	0.40	0.50
c	0.153	0.203	0.253
D	4.80	4.90	5.00
E	3.80	3.90	4.00
E1	5.80	6.00	6.20
L	0.45	0.70	1.00
θ	2°	4°	6°
L1	1.04 REF		
e	1.27 BSC		
R1	0.07 TYP		
R2	0.07 TYP		

Customer Service

Sales and Service:

zj@ztasemi.com